#### M/A-COM

# GaAs Constant Gamma Flip-**Chip Varactor Diode**



#### Features

±NVI =

- Constant Gamma for Linear Tuning •
- Low Parasitic Capacitance
- High Q
- Silicon Nitride Passivation •
- Polyimide Scratch Protection
- Surface Mount Configuration •

#### Description

M/A-COM's MA46H120 is a gallium arsenide flip chip hyperabrupt varactor diode. These devices are fabricated on OMCVD epitaxial wafers using a process designed for high device uniformity and extremely low parasitics. The MA46H120 diodes are fully passivated with silicon nitride and have an additional layer of polyimide for scratch protection. The protective coatings prevent damage to the junction during automated or manual handling. The flip chip configuration is suitable for pick and place insertion.

### Applications

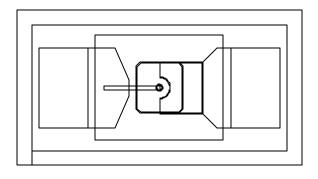
The MA46H120 hyperabrupt GaAs tuning varactor is designed for wide bandwidth VCOs and voltage tuned filters where large capacitance change versus tuning voltage and high Q are required. With a constant gamma of 1.0, these diodes are particularly useful where highly predictable frequency tuning is required.

# Electrical Specifications @ T<sub>A</sub> = +25°C

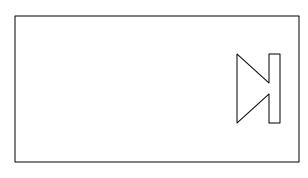
Breakdown Voltage @  $I_R = 10 \text{ mA}$ ,  $V_B = 15V$  Minimum

Chip Layout

**TOP VIEW** 



#### **BOTTOM VIEW**



	Ст		Ст		CT		Q Factor			Gamma					
	(pF)		(pF)		(pF)										
	f=1MHz, V <sub>R</sub> =0V		f=1MHz, V <sub>R</sub> =4V		f=1MHz, V <sub>R</sub> =10V			f=50MHz, V <sub>R</sub> =4V		V <sub>R</sub> =2-12V					
	Min	Тур	Мах	Min	Тур	Мах	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max
MA46H120		1.1		0.30		0.40	0.14		0.20	3000			0.9		1.1

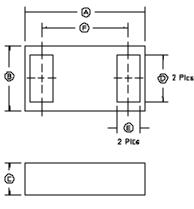


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V3.00

#### Chip Outline Drawing

(ODS-1203)



	INCH	IES	ММ			
DIM	MIN	MAX	MIN	MAX		
А	.025	.027	.64	.69		
В	.012	.015	.32	.37		
С	.006	.008	.15	.20		
D	.007	.009	.17	.22		
E	.004	.006	.10	.15		
F	.018	.020	.45	.50		

### **Mounting Techniques**

These chips were designed to be inserted onto hard or soft substrates with the junction side down. They can be mounted with conductive epoxy or with a low temperature solder preform. The die can also be assembled with the junction side up, and wire or ribbon bonds made to the pads.

### **Solder Die Attachment**

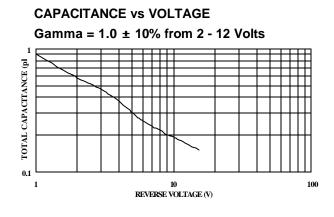
Solder which does not scavenge gold, such as Indalloy #2, is recommended. Sn-Pb based solders are not recommended due to solder embrittlement. Do not expose die to a temperature greater than 235°C, or greater than 200°C for longer than 10 seconds. No more than three seconds of scrub should be required for attachment.

# **Epoxy Die Attachment**

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Assembly can be preheated to 125 - 150°C. Use a minimum amount of epoxy. Cure epoxy per manufacturer's schedule. For extended cure times, temperatures must be kept below 200°C.

### **Typical Performance Curve**



### Absolute Maximum Ratings<sup>1</sup>

Parameter	Maximum Ratings				
Operating Temperature	-40°C to +125°C				
Storage Temperature	-65°C to +150°C				
Power Dissipation	100 mW				
Mounting Temperature	+235°C for 10 seconds				

1. Exceeding these limits may cause permanent damage.

### Handling Procedures

The following precautions should be observed to avoid damaging GaAs Flip-Chips:

### Cleanliness

These chips should be handled in a clean environment. Do not attempt to clean die after installation.

### **Static Sensitivity**

Varactor diodes are ESD sensitive and can be damaged by static electricity. Proper ESD techniques should be followed to when handling these devices.

# **General Handling**

The protective polymer coating on the active areas of these dice provides scratch protection, particularly for the metal airbridge which contacts the anode. Dice can be handled with tweezers or vacuum pickups and are suitable for use with automatic pick-and-place equipment.

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